+ CONNECTORS

DISCRETE SOCKETS

✔ Active

TE CONNECTIVITY (TE)

8134-HC-6P3=HOLTITE 3.3.20

HOLTITE | HOLTITE

8134-HC-6P3
TE Internal Number: 6-1437514-9

Not EU RoHS Compliant

Not EU ELV Compliant

Hole Size (Recommended) 1.47 mm [.058 in]

Socket Length 3.45 mm [.136 in]

Sealant Without

Mating Pin Diameter Range .51 – .76 mm [.02 – .03 in]

Termination Method to PC Board Through Hole - Press-Fit

⬇ **PRODUCT DRAWING**
    English

⬇ **3D PDF**

DOCUMENTATION —

Product Drawings

CONTACT PLATED (REF AUGAT 8134-HC-6P2)

PDF

English

HOLTITE CONTACTS

PDF

English

CAD Files

Customer View Model

3D_IGS.ZIP

English

Customer View Model
3D_STP.ZIP

English

Customer View Model
2D_DXF.ZIP

English

3D PDF
PDF

English

Product Specifications

Application Specification

AUGAT HOLTITE Sockets
PDF

English

Product Specification

AUGAT HOLTITE Sockets
PDF

English

FEATURES   +

Please review product documents or contact us for the latest agency approval information.

Please Note: Use the Product Drawing for all design activity.

Product Type Features

Connector & Contact Terminates To   Printed Circuit Board
Product Type   Contact
Profile   Zero
Wire/Cable Type   Discrete Wire

Body Features

Sealant   Without
Sleeve Plating Material   Tin
Sleeve Material   Copper

Contact Features

Contact Current Rating (Max) (A)   5
Contact Type   Socket
Contact Spring Plating Material   Tin
Contact Transmits (Typical)   Signal (Data)/Power
Contact Base Material   Beryllium Copper
Contact Mating Area Plating Material   Tin-Lead
Socket Type   Discrete

Termination Features

Termination Method to PC Board Through Hole - Press-Fit
Termination Method to Wire/Cable Solder
Insertion Method Hand/Semi-Automatic

Dimensions

Socket Length 3.45 mm [.136 in]
Hole Size (Recommended) 1.47 mm [.058 in]
Mating Pin Diameter Range .51 – .76 mm [.02 – .03 in]
PCB Thickness (Recommended) .79 – 3.18 mm [.03 – .05 in]

Usage Conditions

Operating Temperature Range -65 – 125 °C [-85 – 257 °F]

Packaging Features

Packaging Method Loose Piece
Packaging Quantity 2000

Other

Spring Material Beryllium Copper

PRODUCT COMPLIANCE   +

Statement of Compliance

Statement of Compliance
PDF